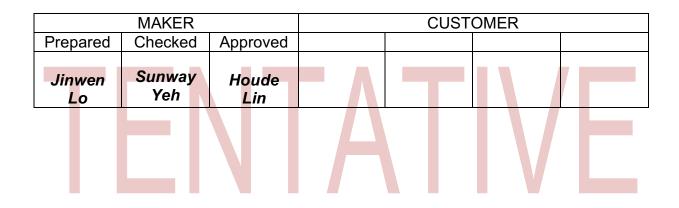


## **APPROVAL SHEET**

AOT MODEL NAME	3528
AOT PART NUMBER	3528C-W306
CUSTOMER NAME	General
DATE	2021 / Apr.
VERSION	01



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### **Revision Note**

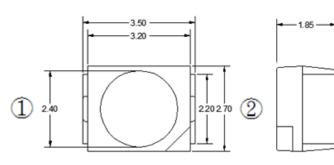
Date	Revision	Page	Version
2021-04-13	Initiate Document	14	01



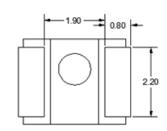
### Package Outline

Model name: 3528C-W306 Unit: mm, Tolerance: ± 0.2 mm

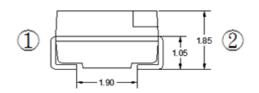
### Top view

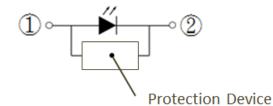


Bottom view

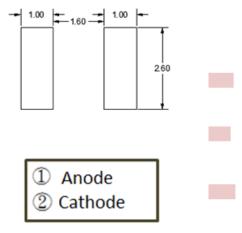


Front view





Recommended Soldering Pad Pattern



Item	Materials
Package	Heat-Resistant Polymer
Encapsulating Material	Silicone(with phosphor)
Electrode	Ag Plating Copper Alloy

- Single blue chip.
- Compact package outline (LxWxH) of 3.5 mm x 2.7 mm x 1.85 mm.
- Compatible with reflow soldering.
- Complies with RoHS Directive.



### Optical/Electronic Characteristics (Ts=25°C)

AOT Reading Standards							
Item Symbol Condition Min Typ. Max Unit							
Forward Voltage	VF	I <sub>F</sub> = 20mA	2.75	-	3.25	V	
Luminous Intensity	Φv	I <sub>F</sub> = 20mA	1400	-	3550	mcd	
Thermal Resistance	R <sub>ths-j</sub>		-	53	-	°C/W	

\* Tolerance of measurements of the Forward Voltage is  $\pm$  0.05 V.

\* Tolerance of measurements of the Luminous Intensity is ± 7%.

\* Tolerance of measurements of the Dominant Wavelength is ± 1nm.

### Absolute Maximum Ratings (Ts=25°C)

Item	Symbol	Absolute Maximum Rating	Unit
Forward Current	lF	30	mA
Power Dissipation	PD	100	mW
Reverse Voltage	VR	5	V
Operating Temperature	T <sub>opr</sub>	-40~+85	°C
Storage Temperature	T <sub>stg</sub>	-40~+85	°C
Soldering Temperature	T <sub>sld</sub>	Reflow Soldering : 260°C for Hand Soldering : 350°C for 3	
Junc <mark>tio</mark> n Temperature	Тј	115	°C
Forward Voltage at Low Current	V <sub>F2</sub>	>1.9 ( @1uA )	V

\* Max condition is not guarantee for life time



### Group Definition of Forward Voltage

Rank	Condition	V <sub>F</sub> (V)
2730	Ts=25°C	2.75 ~ 3.0
3025	l⊧=20mA	3.0 ~ 3.25

### **Group Definition of Brightness**

Rank	Condition	Luminous Intensity(mcd)
AB	T₅=25ºC I⊧=20mA	1400 ~ 1800
BA		1800 ~ 2240
BB		2240 ~ 2800
CA		2800 ~ 3550

\*A shipment shall consist of LEDs in a combination of above ranks.

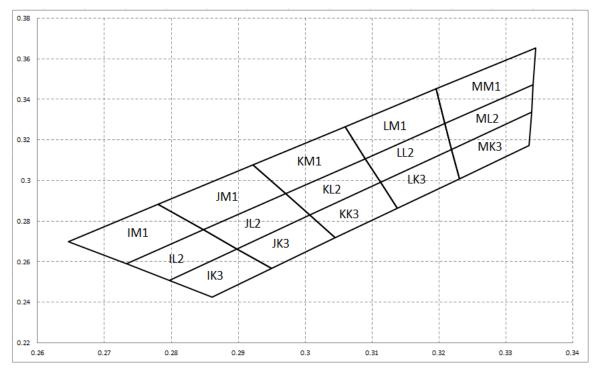
The percentage of each rank in the shipment shall be determined by AOT.

\*The ranking information of LEDs can be found on the reel label.

# FENTATIVE



### Group Definition of Chromaticity Coordinate



## TENTATIVE



### **Color Rank**

Rank	х	У	Rank	х	у	Rank	x	У
	0.2861	0.2427		0.2797	0.2509		0.2733	0.2590
	0.2797	0.2509		0.2733	0.2590	1844	0.2646	0.2700
IK3	0.2898	0.2664	IL2	0.2848	0.2757	IM1	0.2780	0.2883
	0.2950	0.2568		0.2898	0.2664		0.2848	0.2757
	0.2950	0.2568		0.2898	0.2664		0.2848	0.2757
11/2	0.2898	0.2664		0.2848	0.2757	18.4.4	0.2780	0.2883
JK3	0.3007	0.2830	JL2	0.2971	0.2935	JM1	0.2922	0.3077
	0.3045	0.2717		0.3007	0.2830		0.2971	0.2935
	0.3045	0.2717		0.3007	0.2830	KM1	0.2971	0.2935
KK3	0.3007	0.283	KL2	0.2971	0.2935		0.2922	0.3077
KK3	0.3113	0.2992	KL2	0.3090	0.3108		0.3060	0.3266
	0.3138	0.2862		0.3113	0.2992		0.3090	0.3108
	0.3138	0.2862		0.3113	0.2992		0.309	0.3108
	0.3113	0.2992		0.309	0.3108	1 1 1 4	0.306	0.3266
LK3	0.3219	0.3154	LL2	0.3209	0.3281	LM1	0.3196	0.3451
	0.3231	0.3008		0.3 <mark>21</mark> 9	0.3154		0.3209	0.3281
	0.3339	0.3336		0. <mark>3219</mark>	0.3 <mark>15</mark> 4		0.32 <mark>0</mark> 9	0.3281
МКЗ	0.3219	0.3154	ML2	0.3209	0.3 <mark>2</mark> 81	NANA1	0.3196	0.3451
IVIN 3	0.3231	0.3008		0.3341	0.3 <mark>47</mark> 2	MM1	0.3345	0.3654
	0.3335	0.3172		0.3339	0.3 <mark>33</mark> 6		0.3341	0.3472

Note: Chromaticity coordinate groups are measured with an accuracy of ±0.005.



### **Recommended Reflow Soldering Conditions**

### Surface Mounting Condition

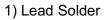
In automatic mounting of the SMD LEDs on printed circuit boards, any bending, expanding and pulling forces or shock against the SMD LEDs should be kept min. to prevent them from electrical failures and mechanical damages of the devices.

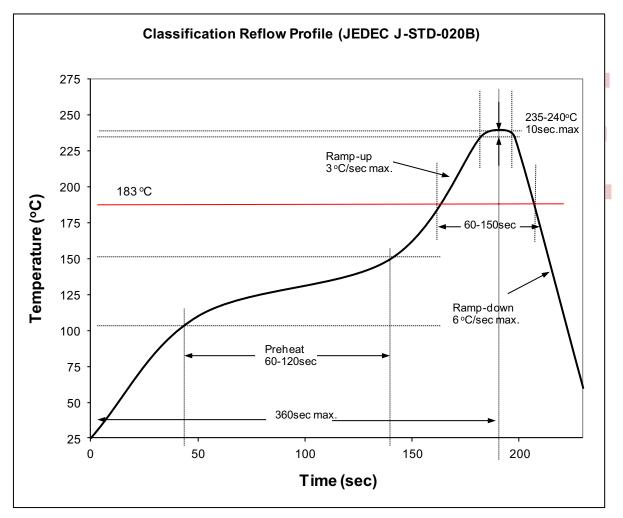
### Soldering Reflow

-Soldering of the SMD LEDs should conform to the soldering condition in the individual specifications. -SMD LEDs are designed for Reflow Soldering.

-In the reflow soldering, too high temperature and too large temperature gradient such as rapid heating/cooling may cause electrical & optical failures and damages of the devices.

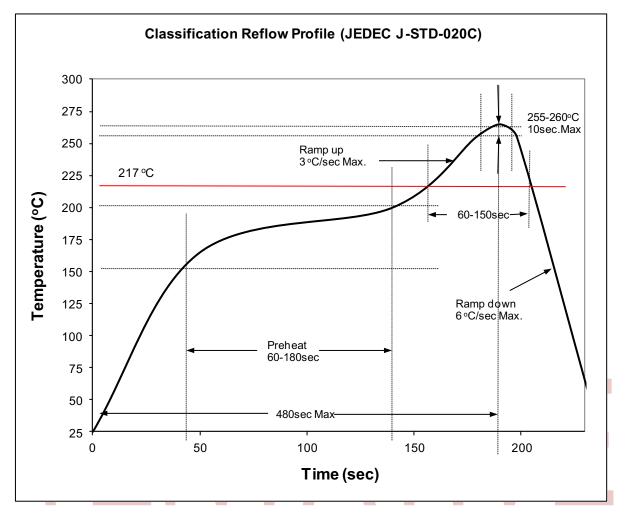
-AOT cannot guarantee the LEDs after they have been assembled using the solder dipping method.







### 2) Lead-Free Solder



### 3) Manual Soldering Conditions

- Lead Solder

Max. 300 °C for Max. 3sec, and only one time.

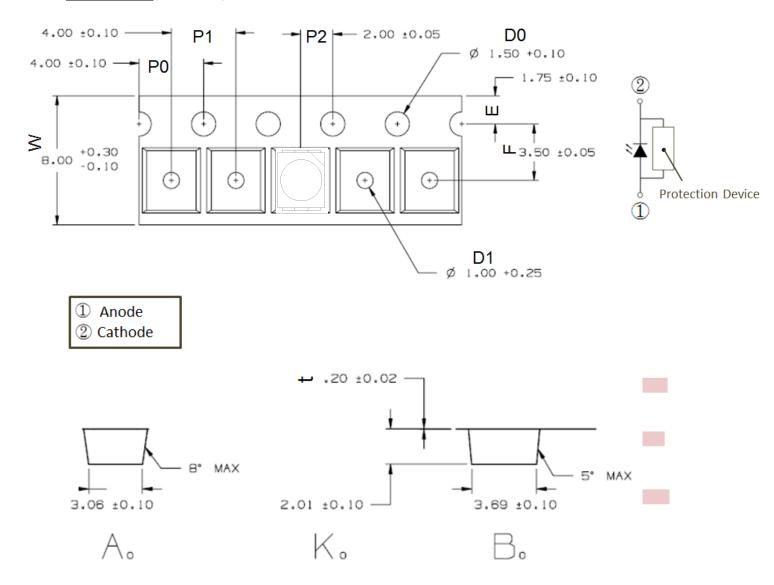
- Lead-free Solder

Max. 350 °C for Max. 3sec, and only one time.

- There is possibility that the brightness of LEDs is decreased, which is influenced by heat or ambient atmosphere during reflow. It is recommended to use the nitrogen reflow method.
- After LEDs have been soldered, repair should not be done. As repair is unavoidable, a double-head soldering iron should be used. It should be confirmed beforehand whether the characteristics of the LEDs will be damaged by repairing or not.
- Reflow soldering should not be done more than two times.



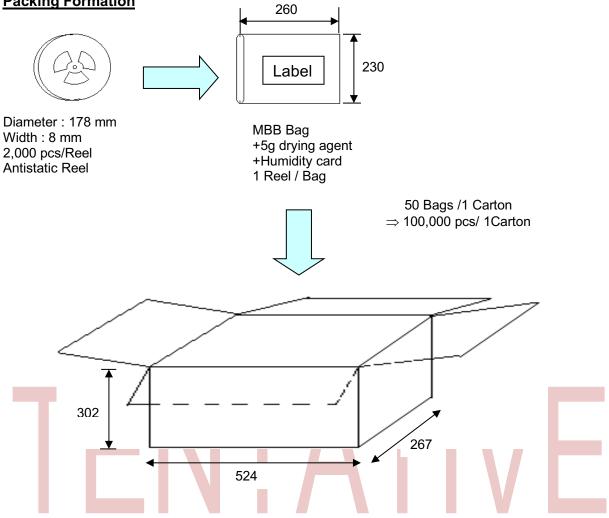
### Dimensions (Unit :mm)



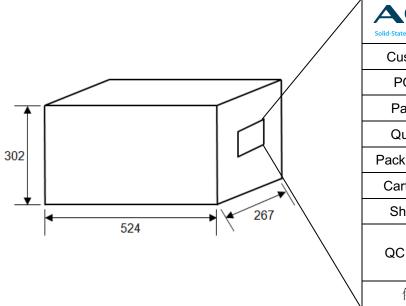
Item	Spec.	Tolerance(mm) Item		Spec.	Tolerance(mm)
w	8.00	+0.30,-0.10	+0.30,-0.10 <b>P1</b>		±0.10
E	1.75	±0.10	P2	2.00	±0.05
F	3.50	±0.05	t	0.20	±0.02
D0	1.50	+0.10,-0	A0	3.06	±0.10
D1	1.00	+0.25	B0	3.69	±0.10
P0	4.00	±0.10	K0	2.01	±0.10



### **Packing Formation**







	Solid-State Light. Done Right. Advanced Optoelectronic Technology Inc.							
	Customer							
	PO No.							
	Part No.							
	Quantity							
	Packing Date							
	Carton No.							
	Ship No.							
	QC Check	DASS PASS PASS PASS WW RoHS PASS Stra Stra Stra						
$\backslash$	備註							



### **Reel Label Definition**

		SAP. No.
SMD LED		
Part Numbe	r : XXXXX-XXXX	
Brightness	: A	
CIĔ	: B	
VF	: C	
Quantity	: nn ea	
Serial No	: SM0yymmddxxxx	SASS PASS PASS
		(ª R∩HS ≹)
Cust. PN.	: XXXXX-XXXX	
0000.111		ALE SZAR 29

A : Iv value. B : CIE value noted C : Vf value. nn : Quantity of LED

SM0yymmddxxx : yy : year, mm : month, dd : day, xxxx : reel no.

\*Reel Label to fill in practice data of all LED characteristic



### **Cautions**

(1) Moisture Proof Package

The moisture proof package should be used to prevent moisture in the package as the moisture may Cause damage to optical characteristics of the LEDs.

The aluminum bag with zipper is used for moisture proof package. And, the moisture absorbent Material, Silica gel, is inserted into aluminum bag.

- (2) Storage:
  - Storage Conditions

Before opening the package:

The LEDs should be kept at 30°C or less than 90%RH or less. The LEDs should be used within a year. When storing the LEDs, moisture proof packaging with absorbent material is recommended. After opening the package:

After open the package, the LED should be kept at 30°C, 60%RH or less. The LED should be soldered within 168 hours (7 days) after opening the package. If unused LEDs remain, it should be stored in moisture proof condition.

(3) Heat Generation

Thermal design of the end products is of paramount importance. The heat generation must be taken into design consideration when using the LED. The coefficient of the temperature increase per input electric power is affected by the thermal resistance of the circuit board and density of LED placement on the board, as well as other components.

(4) Static Electricity

Static electricity or surge voltage damages the LEDs. All equipment and machinery must be properly grounded. It is recommended to use a wristband or anti-electrostatic glove when handing the LEDs. When inspecting the final products in which LEDs were assembled, it is recommended to check whether the assembled LEDs are damaged by static electricity or not. It is easy to find static-damaged LEDs by a light-on test or a Vf test at a lower current. (Below 1mA is recommended). Criteria:  $V_F>1.9V$  at  $I_F=1uA$ 

(5) Cleaning

Use isopropyl alcohol as a solvent for cleaning the LEDs. The other solvent may dissolve the LEDs package and the epoxy.

Ultrasonic cleaning should not be done.

(6) Electrostatic Discharge (ESD)

The products are sensitive to static electricity or surge voltage, An ESD event may damage its die or reduce its reliability performance. When handling the products, measures against electro static discharge, including the followings, are strongly recommended.

Eliminating the charge;

Wrist strap, ESD footwear and garments, ESD floors



Grounding the equipment and tools at workstation

ESD table / shelf mat (conductive materials)

Proper grounding techniques are required for all devices, equipment and machinery used in the assembly of the products, Also note that surge protection should be considered in the design of customer products.

If tools or equipment contain insulating materials, such as glass or plastic, proper measures against electro static discharge, including the followings are strongly recommended.

Dissipating the charge with conductive materials

Preventing the charge generation with moisture

Neutralizing the charge with ionizer

When performing the characteristics inspection of the LEDs in your application, customer is advised to check on the LEDs whether or not they are damaged by ESD, Such damage can be detected during forward voltage measurement or light up test at low current. (The recommended current is 1mA or lower)

ESD-damaged LEDs may have a current flow at low voltage, or no longer light up at low current, Failure Criteria:  $V_F < 1.9V$  at  $I_F=1uA$ 

### (7) Others

When using the LEDs, it must care that the reverse voltage will not exceed the absolute maximum rating. The LED light is enough to injure human eyes, so it should avoid looking at LED light directly.

NOTE.		

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